

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT												
NATURE OF CONVEYANCE:	Corrective Assignment to correct the name of the Assignee previously recorded on Reel 024511 Frame 0541. Assignor(s) hereby confirms the Assignee name is NATIONAL CHENG KUNG UNIVERSITY, as per the Assignment.												
CONVEYING PARTY DATA													
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Gwo Bin LEE</td> <td>04/16/2011</td> </tr> <tr> <td>Sung Yi YANG</td> <td>04/15/2011</td> </tr> <tr> <td>Song Bin HUANG</td> <td>04/15/2011</td> </tr> <tr> <td>Kang Yi LIEN</td> <td>04/15/2011</td> </tr> <tr> <td>Chen Hsun WENG</td> <td>04/15/2011</td> </tr> </tbody> </table>		Name	Execution Date	Gwo Bin LEE	04/16/2011	Sung Yi YANG	04/15/2011	Song Bin HUANG	04/15/2011	Kang Yi LIEN	04/15/2011	Chen Hsun WENG	04/15/2011
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<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>NATIONAL CHENG KUNG UNIVERSITY</td> </tr> <tr> <td>Street Address:</td> <td>No. 1, Ta Hsueh Rd.</td> </tr> <tr> <td>City:</td> <td>Tainan City</td> </tr> <tr> <td>State/Country:</td> <td>TAIWAN</td> </tr> </table>		Name:	NATIONAL CHENG KUNG UNIVERSITY	Street Address:	No. 1, Ta Hsueh Rd.	City:	Tainan City	State/Country:	TAIWAN				
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CORRESPONDENCE DATA													
<p>Fax Number: (703)205-8050 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 703-205-8000 Email: twyatt@bskb.com Correspondent Name: Birch, Stewart, Kolasch & Birch, LLP Address Line 1: P.O. Box 747 Address Line 4: Falls Church, VIRGINIA 22040-0747</p>													
ATTORNEY DOCKET NUMBER:	5025-0203PUS1												
NAME OF SUBMITTER:	Paul C. Lewis												

CH \$40.00 12795445

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PATENT
REEL: 026305 FRAME: 0013

Total Attachments: 6

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PATENT ASSIGNMENT

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06/09/2010
501200297

SUBMISSION TYPE:	NEW ASSIGNMENT												
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Phone: 703-205-8000													
Email: yolanda.askew-sampson@bskb.com													
Correspondent Name: BIRCH, STEWART, KOLASCH & BIRCH, LLP													
Address Line 1: P.O. BOX 747													
Address Line 4: FALLS CHURCH, VIRGINIA 22040-0747													
ATTORNEY DOCKET NUMBER:	5025-0203PUS1												
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Total Attachments: 2 source=20100607ASSIGNMENT#page1.tif													

CH \$40.00 12795445

PATENT
REEL: 026305 FRAME: 0015

BIRCH, STEWART, KOLASCH & BIRCH, LLP

UNITED STATES PATENT RIGHTS, OR
UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

ASSIGNMENT

Application No. 12/795,445Filed June 7, 2010Insert Name(s)
of Inventor(s)

*** (Given Name FAMILY NAME (ALL CAPS)) ***

WHEREAS,	GWO BIN/LEE	SUNG YI/YANG
SONG BIN/HUANG	KANG YI/ LIEN	CHEN HSUN/WENG
_____	_____	_____
_____	_____	_____
_____	_____	_____

(hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in

Insert Title
of InventionMicrofluidic Biochip

for which an application for Letters Patent of the United States of America has been executed by the undersigned (except in the case of a provisional application).

Insert Date
of Signing of
Applicationon April 15, 2011 and April 16, 2011; andInsert Name
of AssigneeWHEREAS, NATIONAL CHENG KUNG UNIVERSITYInsert Address
of Assigneeof No.1, Ta Hsueh Rd. Tainan City, Taiwan R.O.C.

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and

CHECK BOX
IF APPROPRIATE☐ in any foreign countries.

NOW, THEREFORE, in consideration of the sum of Ten Dollars (\$10.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries;

and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree (s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

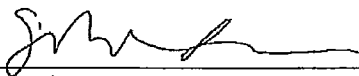
The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date 2011. 4. 16

Name of Inventor 
(signature) GWO BIN/LEE

Date 2011. 4. 15

Name of Inventor Sung-Yi Yang
(signature) SUNG YI/YANG

Date 2011. 4. 15

Name of Inventor Song-Bin Huang
(signature) SONG BIN/ HUANG

Date 2011. 4. 15

Name of Inventor 
(signature) KANG YI/ LIEN

Date 2011. 4. 15

Name of Inventor Chen Hsun Weng
(signature) CHEN HSUN/WENG

Date _____

Name of Inventor _____
(signature)